

TITLE OF THE INVENTION

AN APPARATUS AND METHOD FOR CONTROLLING ACCESS TO A MEMORY SYSTEM FOR ELECTRONIC EQUIPMENT

BACKGROUND OF THE INVENTION

Field of the Invention

The present invention relates to an apparatus and method for controlling access to a memory system comprising a plurality of memory modules for electronic equipment. More particularly, the present invention relates to an apparatus and method for controlling access to a plurality of memory modules comprising different types of modules that are coupled to a memory controller in series, in order to achieve higher operating speed.

The widespread and diverse use of electronic equipment, and personal computers in particular, creates a strong demand to increase the data processing speed and amount of data that can be processed. Increases in data processing speed have been achieved by increasing the operating clock frequency for the central processing unit (CPU) of the electronic equipment. Further increases in data processing speed are possible by increasing the operating frequency of the installed memory modules and the data transfer bus of the electronic equipment.

The amount of data processed has been increased by adding expansion memory, in addition to the installed memory, in the electronic equipment. In the same way that a CPU has a particular operating frequency, expansion memory modules have a designated operating frequency. Conventional expansion memory modules typically have an operating frequency of 66 MHz. Recently, expansion memory modules have been developed that have an operating frequency of 100 MHz.

However, the performance of conventional expansion memory systems is limited by certain inherent design limitations, as shown in Figure 4. Figure 4 illustrates a conventional

expansion memory system, which includes a memory controller **401** and a plurality of memory slots **402, 403, 404** for installing a plurality of memory modules that are connected to the memory controller **401** in parallel. Thus, the plurality of memory slots **402, 403, 404** contain a plurality of memory modules or cards **405, 406, 407**, respectively. Since the memory modules are coupled to the memory controller **401** in parallel, as illustrated in Figure 4, the memory bus for the conventional expansion memory system includes a plurality of connecting branch points **B1, B2** between the memory controller **401** and each expansion memory module.

Consequently, when a plurality of memory modules having an operating frequency of 100 MHz are installed in the slots to increase the data processing speed, noises are generated by signal reflections at the connecting branch points of the memory bus. These noises interfere with normal operation of the computer system. Thus, the architecture of a conventional memory system limits the operating speed.

Figure 5 illustrates an alternative memory system architecture that eliminates the problem of noise generated by signal reflections at the connecting branch points. The memory system shown in Figure 5 uses a plurality of memory module slots that are connected to the memory controller in series. Thus, this memory system architecture can realize a higher speed of operation by eliminating the branch points of the memory bus that generate the undesired reflections.

In Figure 5, the memory controller **501** is connected to a first expansion memory slot **502**. The first expansion memory slot **502** is connected to a second expansion memory slot **503**. Similarly, the second expansion memory slot **503** is connected to a third expansion memory slot **504**. Thus, the plurality of memory slots is connected in series to the memory controller. Finally, the third expansion memory slot **504** is connected to a terminator **508** to prevent signal reflections. Each memory slot accepts one of expansion memory modules **505, 506, and 507**.

One such memory module system, that achieves higher operating speed by chaining a plurality of expansion memory slots in series, has been introduced as the RAMBUS® DRAM by RAMBUS®, Inc. However, the RAMBUS® memory system architecture has a different limitation that makes it undesirable for small electronic equipment, especially for personal computers. As illustrated in Figure 5, the memory architecture incorporates only slot-type

memory modules. Thus, all of the memory modules must be installed in slots on a board in the electronic equipment. Consequently, the RAMBUS® architecture requires a significant increase in installation area to provide the plurality of memory slots in the electronic equipment. The increase of the installation area to provide the plurality of slots is extremely undesirable for small electronic equipment, especially for personal computers.

Instead of exclusively using memory slots, it is preferable to decrease the installation area by installing a memory module directly on the board. Hereinafter, a memory module that is installed directly on the board is referred to as an on-board type memory module and a memory module that is installed in a memory slot is referred to as a slot-type memory module.

Since the on-board type memory module is installed directly on the board during the manufacture of the electronic equipment, it is impossible for a user to change it even if there are defects in the on-board type memory module. Consequently, if the memory architecture uses only on-board type memory modules, a user cannot correct malfunctions in the computer system due to defects in the installed memory module.

Therefore, there is a need for a memory module system that achieves a higher operation speed by utilizing both on-board type memory modules and slot-type memory modules, to reduce the need to increase the installation area. Further, there is a need for a method for controlling access to the expansion memory modules utilizing both of the on-board type memory module and the slot type memory modules that avoids malfunctions in the computer system due to limitations of the memory modules.

SUMMARY OF THE INVENTION

The apparatus and method of the present invention solve the aforementioned problems and overcomes the limitations of conventional memory module systems by providing a memory control apparatus and method that reliably achieve memory access control at higher operating speeds when memory modules are installed in the memory system.

According to the present invention, there is provided electronic equipment, comprising a board for receiving a plurality of memory modules, the board including an on-board memory area

for installing on-board type memory modules, and a slot-type memory area for installing slot-type memory modules; at least one on-board type memory module installed in the on-board memory area, each on-board type memory module having a specified operating frequency; at least one memory slot provided in the slot-type memory area, each memory slot being coupled in series to the on-board memory module; at least one slot-type memory module, installed in the memory slot in the slot-type memory area, each slot-type memory module having a specified operating frequency; a memory controller coupled in series to the on-board memory and slot-type memory modules, the memory controller providing access using a designated operating frequency; and a memory bus that couples the memory controller to the on-board memory and slot-type memory modules in series.

There is also provided a method for controlling start-up operation of electronic equipment that includes a plurality of memory modules coupled in series, comprising the steps of providing an on-board memory area including at least one on-board type memory module in the electronic equipment; providing a slot-type memory area including at least one memory slot, each memory slot being coupled to the on-board memory in series; installing at least one slot-type memory module in the at least one memory slot; and providing a memory controller, coupled in series to the on-board memory and slot-type memory, that controls access to the on-board and slot-type memory modules.

There is also provided a method for controlling start-up operation of *electronic* equipment comprising the steps of providing at least one on-board type memory module and at least one slot for receiving at least one slot-type memory module, each of the on-board and slot-type memory modules having attribute information; providing at least one board for mounting the at least one on-board type memory module and the at least one slot for receiving the at least one slot-type memory module; mounting the at least one on-board type memory module on the board; determining whether one of the on-board type and slot-type memory modules is defective based on the attribute information; and controlling a start-up operation of the electronic equipment based on the determination.

Both the foregoing general description and the following detailed description are exemplary and explanatory only and do not restrict the present invention as claimed. The foregoing merely provides further explanation of the claimed invention. The accompanying

drawings, which are incorporated in and constitute a part of this specification, illustrate embodiments of the present invention and, together with the description, explain the principles of the present invention.

BRIEF DESCRIPTION OF THE DRAWINGS

Figure 1 depicts a method for mounting a plurality of different types of memory modules in series, consistent with the present invention.

Figure 2 depicts the main components of a personal computer system that employs the method for mounting the plurality of different types of memory modules depicted in Figure 1.

Figure 3 depicts steps performed for the start up operation of an embodiment of the personal computer system as depicted in Figure 2.

Figure 4 depicts a conventional method for mounting a plurality of memory modules in parallel for a low-speed memory system.

Figure 5 depicts a conventional method for mounting a plurality of memory modules in series for a high-speed memory system.

DETAILED DESCRIPTION

Methods and systems consistent with the present invention provide a new method for mounting a plurality of memory modules of different types. This mounting method allows efficient mounting of a mixture of memory modules in a small mounting area with a low manufacturing cost.

Figures 1 and 2 illustrate the main components of a memory control apparatus, consistent with the present invention. Figure 1 illustrates the coupling of a plurality of discrete memory modules in series in a manner consistent with the present invention. Figure 2 illustrates the main components of a personal computer (PC) system 10 in which the memory modules are mounted. Memory control apparatus consistent with the present invention can be implemented in a computer system, such as a laptop or notebook personal computer (PC) system or any computer

system, that typically has an on-board type expansion memory module and slot-type expansion memory modules mounted in memory slots. One of skill in the art can appreciate that the computer system can provide for more or less than two slots for memory modules.

The main components of the memory control apparatus in the PC system **10** comprise a CPU **11**, a HOST-PCI bridge **12**, a first expansion memory module **13** mounted on a board, a second expansion memory module **14** installed in a first expansion memory slot **16**, a third expansion memory module **15** installed in a second expansion memory slot **17**, a terminator **18**, a Peripheral Component Interconnect/ Industry Standard Architecture (PCI/ISA) bridge **19**, a BIOS-ROM **20**, a graphic controller **21**, a monitor **22**, a first analog switch **30**, a second analog switch **31**, a third analog switch **32**, a CPU (processor) bus **1**, a Peripheral Component Interconnect (PCI) bus **2**, an Industrial Standard Architecture (ISA) bus **3**, and a memory bus **4**.

The CPU **11** controls the execution of application programs, including programs on a system BIOS **210**, based on an operating system (OS). The Host-PCI bridge **12** is a bridge device for bidirectionally coupling the CPU bus **1** and the PCI bus **2**. The Host-PCI bridge **12** contains a memory controller **121** for controlling access to the expansion memories. The first on-board memory module **13** is installed in the nearest phase to the memory controller **121**. The second and third expansion memory modules **14**, **15** are respectively installed in the first and second expansion memory slots **16**, **17** that are positioned at a more distant phase position than the installed position of the first on-board memory module **13** from the memory controller **121**.

The expansion memory slots **16**, **17** have the same connector configuration for installing both of the second and third expansion memory modules **14**, **15**, each of which may or may not have a different specified operating frequency with each other. For example, the memory module **14** installed in the first expansion memory slot **16** could have a specified operating frequency of 66 MHz, and the memory module **15** installed in the second expansion memory slot **17** could have a specified operating frequency of 100 MHz.

When both of the memory modules **14**, **15** are installed in the respective expansion memory slots **16**, **17**, the first on-board memory module **13**, the second memory module **14** and the third memory module **15** are coupled to the memory controller **121** in series, like a daisy chain.

The first memory module **13** is installed during the manufacture of the computer system **10**. Consequently, after the completion of the manufacture, it is hard for a user to change or expand the first memory module **13**. The second and third memory modules **14**, **15** also are also installed in the respective expansion memory slots **16**, **17** during the manufacturing process. However, it is hard for a user to replace the memory modules with other memory modules having the same or different operating frequencies.

The access control to each of the memory modules **13**, **14** and **15** from the memory controller **121** can be performed through the memory bus **4**. The memory bus **4** in the computer system **10** is designated so as to operate at an established operating frequency, for example, of 100 MHz. Of course, it is possible to change the designated operating frequency for the memory bus **4**. In order to change the designated operating frequency for the memory bus **4**, the memory controller **121** selects a desired clock signal that is generated from a clock generator (not shown) for operating the memory bus **4**.

Each of the first, second and third memory modules **13**, **14** and **15** comprises a plurality of chips mounted on a base plate. Further, the respective memory modules **13**, **14** and **15** include electrically erasable and programmable read-only memory (EEPROM)s, **131**, **141** and **151**, for storing attribute information for the respective memory modules. The attribute information for each module can include the specified operating frequency, memory size, name of manufacturer, or any other type of information describing the module.

Each of the first, second and third memory modules **13**, **14** and **15** includes a signal line for reading the data from each of the EEPROMs in the memory modules. As shown in Figure 2, a data reading signal line **132** provided in the mounting unit for the first memory module **13** reads the data in the EEPROM **131** for the first memory module **13**. The signal line **132** is coupled to the PCI/ISA bridge **19** through the first analog switch **30**. A data reading signal line **142** provided in the first expansion memory slot **16** reads the data in the EEPROM **141** for the second memory module **14**. The signal line **142** is coupled to the PCI/ISA bridge **19** through the second analog switch **31**. Similarly, a data reading signal line **152** provided in the second expansion memory slot **17** reads the data in the EEPROM **151** for the third memory module **15**.

through the third analog switch **32**. The signal line **152** is coupled to the PCI/ISA bridge **19**. It is possible to use a serial bus, such as a I²C bus as the data reading signal lines **132**, **142** and **152**.

The ON/OFF operations of the first, second and third analog switches **30**, **31** and **32** are controlled by switching signals **193**, **194** and **195** from a switching control circuit **191** provided in the PCI/ISA bridge **19**. Thus, the first, second and third analog switches **30**, **31** and **32** are turned on/off by the switching signals **193**, **194** and **195** from the switching control circuit **191** in due order. Therefore, it is possible to access the EEPROM **131** in the first memory module **13**, the EEPROM **141** in the second memory module **14**, and the EEPROM **151** in the third memory module **15**, in order.

In the embodiment shown in Figure 2, the data reading signal lines **132**, **142** and **152** are used to read the operating frequencies of the respective memory modules from the respective EEPROMs **131**, **141** and **151**. The data reading signal lines **132**, **142** and **152** are independent from the memory bus **4**. Thus, it becomes possible to control access to the memory module even before designating the operating condition for the memory bus **4** at the operating frequency.

The PCI/ISA bridge **19** connects bi-directionally between the PCI bus **2** and the ISA bus **3**. The PCI/ISA bridge **19** includes the switching control circuit **191** for controlling ON/OFF operations of the analog switches **30**, **31** and **32** for accessing to the EEPROMs **131**, **141** and **151** in order to read the specified operating through the I²C bus. The controls of the ON/OFF operations of the analog switches **30**, **31** and **32** and the access to the EEPROMs **131**, **141** and **151** are executed by a System BIOS **210** provided in the Basic I/O System (BIOS) ROM **20**.

A display monitor **22** can be included in the system for displaying screens generated by the OS or the application programs. The display monitor **22** is used for displaying a warning message regarding installation of an improper memory module having a different operating frequency from the established operating frequency for the computer system. In order to display the message, the monitor is coupled to the System-BIOS through a graphic controller **21**, the PCI bus **2** and the ISA bus **3**. Thus, the System-BIOS **210** controls the display of a message on the monitor **22**.

The BIOS-ROM **20** stores the System-BIOS **210**. The BIOS-ROM **20** comprises flash memories, which are capable of writing over the programs and can be operated in real mode.

The System-BIOS **210** includes the Power-On Self Test (POST) routine **220** for self-checking normal operations of the hardware devices in the computer system when the main power switch is on or when the computer system is restarted. Further, the System-BIOS **210** includes device drivers for controlling the various I/O devices, a BIOS setup routine for establishing system environments, and the system managing programs for executing various System Management Interrupt (SMI) operations.

The POST routine **220** includes the normal hardware checking routines and initialization routines. Further, the POST routine **220** includes a checking routine for examining the specified operating frequency in the attribute information of each memory module and for displaying a message on the display monitor **22** when an improper memory module, having a specified operating frequency different from the operating frequency of the computer system, is mounted in the memory expansion slot.

Figure 3 depicts a flow chart of the steps of the POST operation of the computer system consistent with the present invention.

When the main power for the computer system is turned on, the system BIOS is started and the POST operation is started (Step **S101**).

The ON/OFF control operations for the analog switches are executed in order to access the memory modules. Thus, the first, second and third analog switches **30**, **31** and **32** are cycled on and off, in turn, in order to read the attribute information in the EEPROMS **131**, **141**, and **151** for the memory modules **13**, **14** and **15**, respectively (Step **S102**). Reading the attribute information for each memory module gives the respective operating frequency for each memory module. Further, by examining the operating frequency attributes of the memory modules, the memory controller can detect whether a defective memory module is mixed among the first, second and third memory modules **13**, **14** and **15**. Thus, based on the data from the respective read operations, the System-BIOS **210** determines whether there is a defective memory module among the memory modules (Step **S103**).

If a defective memory module is detected among the memory modules (Step **S103**, Yes), the System-BIOS **210** determines whether the defective memory module is mounted on the board, i.e. an on-board type memory module **13** (Step **S104**). If the defective memory module is

an on-board type memory module **13** (Step **S104**, Yes), the start up operation for the computer system is stopped (Step **S105**).

The reason for stopping the starting operation is that the plurality of memory modules is connected in series. In this embodiment, the on-board type memory module is first in series with the memory controller; therefore, it is impossible to assure normal operation, even if both of the slot-type memory modules are working properly. Consequently, when an on-board memory module is determined to be defective, the start-up operation for the computer system is stopped to avoid malfunctions in the computer system.

When an on-board type memory module is determined to be defective, it is also possible to display an error message on the display monitor **22** or to notify a user by a warning sound, such as a beep sound, in order to change or repair the defective memory module.

On the other hand, if the defective module is not an on-board type memory module, i.e., a slot-type memory module is determined to be the defective module (Step **S104**, No), the System-BIOS **210** displays a warning message on the display monitor **22** (Step **S108**).

After displaying the warning message, the computer system continues the start-up operation by using only on-board type memory (Step **S109**).

Returning to Step **S103**, if there are no defective memory modules (Step **S103**, No), then the System-BIOS **210** determines whether the operating frequencies for the respective memory modules are the same, based on the data read from the attribute information (Step **S106**).

If all of the operating frequencies for the respective memory modules are the same (Step **S106**, Yes), the computer starts normal operation by establishing the common operating frequency in the respective registers (not shown) in the respective memory modules (Step **S107**).

If all of the operating frequencies for the respective memory modules are not the same, i.e., some of the operating frequencies are different from each other (Step **S106**, No), the System-BIOS **210** displays a warning message on the display monitor (Step **S108**). As explained above, after displaying the warning message, the computer system enters start-up operations by using only the on-board type memory (Step **S109**).

As another embodiment, if all of the operating frequencies for the respective memory modules are not the same (Step **S106**, No), it is also possible to change the designation of the operating frequency.

For example, if the operating frequencies for the slot-type memory modules **14** and **15** are lower than the operating frequency for the on-board type memory module, and the on-board type memory module is operable at the operating frequency of the slot-type memory modules **14** and **15**, two alternate operating methods are possible for the memory system.

The first method maximizes the memory capacity of the memory modules. Thus, if the operating frequency for the on-board type memory module, i.e. the first memory module **13**, is higher than the operating frequency for the slot-type memory modules, the operating frequency for the on-board type memory module is set to the lower operating frequency of the slot-type memory modules, to allow use of all the memory modules. By selecting the lower operating frequency for the memory modules, it is possible to maximize the memory capacity by ensuring that all memory modules will function properly.

The second method maximizes the operating frequency of the memory modules. When the operating frequency of the on-board type memory module is higher than the operating frequency of the slot-type memory modules, then only the on-board memory module is used. By selecting the higher operating frequency of the on-board memory module, it is possible to attain the maximum operating frequency, although the memory capacity of the system is decreased.

In order to select these designations during the start up operations, the user may select which method to use after Step **S108** and before the controller continues the start-up operation.

Further, the required information, such as a preference for maximum memory capacity or an assured operating frequency, may be stored in the on-board type memory module, in the BIOS-ROM **20**, eliminating the need for EEPROM **131** in memory module **13**. Thus, the information for the on-board type memory module is stored in the computer system, further reducing the required mounting area and cost.

In the above-mentioned embodiments, the System-BIOS **210** executes various operations for the memory modules. However, it is also possible to execute the operations by using other firmware.

